

Visualizing Carbon Nanotubes with LV FE-SEM

Application Note

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Introduction

Carbon nanotubes (CNTs) are allotropes of carbon with a cylindrical nanostructure. These cylindrical carbon molecules have unusual properties which are valuable for electronics, optics and other fields of materials science. In particular, owing to their extraordinary thermal conductivity and mechanical and electrical properties, carbon nanotubes may find applications as additives to various materials.

Carbon nanotubes are members of the fullerene structural family, which also includes the spherical Buckyballs, and the ends of a nanotube may be capped with a hemisphere of the Buckyball structure. Their name is derived from their hollow, tube-like, structure with the walls formed by one-atom-thick sheets of hexagonal carbon, called graphene. Conceptually, these sheets are "rolled"

at specific, discrete chiral angles. The combination of the rolling angle and tube radius dictates the nanotube properties; for example, whether the individual nanotube behaves as a metal or semiconductor. The chemical bonding in nanotubes is composed almost entirely of sp² bonds, similar to those in graphite. These bonds, which are stronger than the sp³ bonds found in alkanes, provide nanotubes with their unique strength and electrical properties. Nanotubes are categorized as single-walled nanotubes (SWNTs) and multi-walled nanotubes (MWNTs). Individual nanotubes naturally align themselves into rope-like strands held together by van der Waals forces.

The fields of potential application for CNT materials are quite broad, including structural applications, electromagnetic, electroacoustic, chemical, mechanical, electronic devices and circuits, and medicine. Some of the critical factors for nanotubes are purity, dispersability, electrical and mechanical properties, and morphology. Because of their nanoscale size, scanning electron microscopy (SEM), transmission electron microscopy (TEM) and scanning probe microscopies have dominated the techniques used to visualize CNTs.

Agilent's 8500 FE-SEM is a low voltage, field emission SEM which employs a novel electrostatic lens design. This innovative design allows for high resolution imaging of CNTs and CNT composites, typically without the need for metal coating. The 8500 FE-SEM was used to image CNT dispersions on titanium coated silicon[1] substrate and as a microelectrode coating.[2]

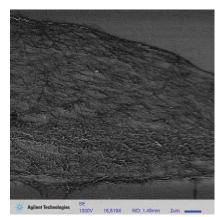


Figure 1. CNT dispersed on titanium coated silicon wafer.

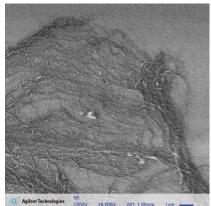


Figure 2. CNT dispersed on titanium coated silicon wafer.

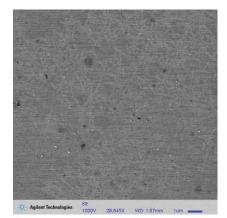


Figure 3. CNT dispersed on titanium coated silicon wafer.



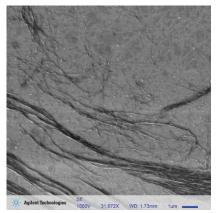


Figure 4A. CNT dispersed on titanium coated silicon wafer.

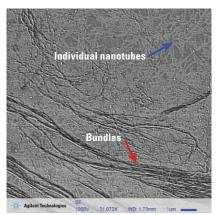


Figure 4B. CNT dispersed on titanium coated silicon wafer.

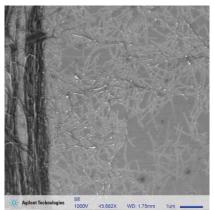


Figure 5. CNT dispersed on titanium coated silicon wafer.

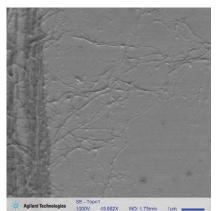


Figure 6. CNT dispersed on titanium coated silicon wafer.

CNT Dispersed on Titanium Coated Silicon Substrate

SWNTs have unique electrical properties that could be beneficial in a wide variety of electronic devices. Catalytic growth of individual nanotubes to form devices is a time-consuming tedious process that is prone to defects. Therefore the manufacturing scale production of SWNT based devices will likely rely on the purification and dispersion of nanotubes onto preformed electrical contacts.[3] LV FE-SEM is a fast, convenient way to examine these structures. However, recent work has shown the measured diameter of CNTs using FE-SEM is over-estimated. [4–7] There are two theories that attempt to explain the discrepancy in the diameter measurement; both are related to localized sample-substrateelectron beam interactions. The first theory is that electron beam induced

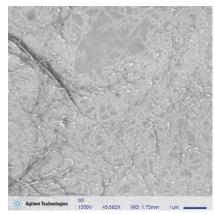


Figure 7. CNT dispersed on titanium coated silicon wafer.

charge contrast based on the nanotube substrate dielectric mismatch results in the observed increase in diameter. [4,5] The second theory is that electron beam induced emission from the nanotubes results in the observed increase in diameter.[6,7]

LV FE-SEM with an accelerating voltage of 1kV was used to examine SWNTs dispersed on titanium coated silicon substrate, see Figures 1–13. The observed nanotube bundles yield images with the expected morphology and dimensions. Images that contain both bundles and individual nanotubes show the individual nanotubes have a different contrast mechanism as well as an exaggerated diameter, which is phenomenologically consistent with both proposed theories in the literature. The presence and morphology of the nanotube bundles does not appear to

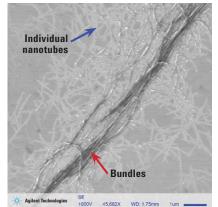


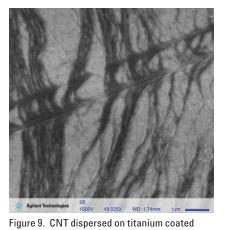
Figure 8. CNT dispersed on titanium coated silicon wafer.

influence the morphology and dispersion of the individual SWNTs (Figures 4, 5, 7, 8, and 12). Figures 3 and 4A show typical images for individual SWNTs, however Figure 4B shows the improved visualization of individual nanotubes by applying a contrast-limited adaptive histogram expansion filter.

Although LV FE-SEM does not provide accurate measurement of the SWNT's very small diameter, it does provide a fast, convenient way to evaluate the location, length, density, and morphology of the nanotubes.

Electrodeposited CNT on Microelectrode

Implanting microelectrodes in the nervous system to study and treat neural diseases is becoming commonplace. Neurophysiologists have used wire



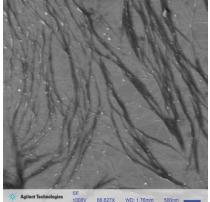


Figure 10. CNT dispersed on titanium coated silicon wafer.

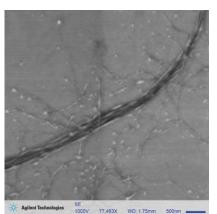
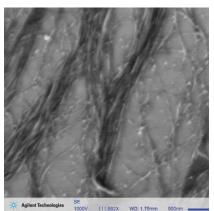


Figure 11. CNT dispersed on titanium coated silicon wafer.



silicon wafer.

Figure 12. CNT dispersed on titanium coated silicon wafer.

based microelectrodes to study brain function and treat disease for the last 5 decades. However, the ultimate success of these experiments depends on the microelectrode-brain tissue interface. The high surface area and unique electrical properties of CNTs make them an interesting candidate to improve the microelectrode interface.

LV FE-SEM with 1 kV accelerating voltage was used to examine the surface structure and morphology of CNT coated microelectrodes used in neurophysiology, see Figures 14–19. The images, progressing from Figure 14 to Figure 19, show an increasing level of detail in the CNT coating as the field size (scan area) is reduced. Figure 14 shows the comparison of a secondary electron image to a topographic mode image of a CNT coated microelectrode. The topographic view is generated by

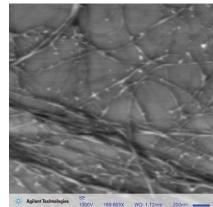


Figure 13. CNT dispersed on titanium coated silicon wafer.



Figure 14A. CNT coated microelectrode.



Figure 14B. CNT coated microelectrode, topographic view of figure 14A.

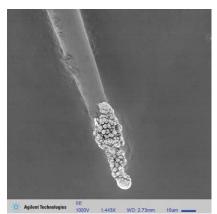


Figure 15. CNT coated microelectrode.

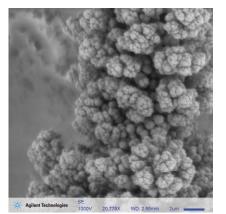


Figure 16. CNT coated microelectrode.

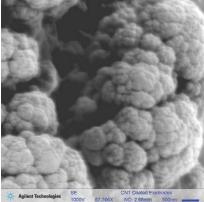


Figure 17. CNT coated microelectrode.

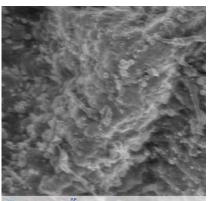


Figure 18. CNT coated microelectrode.

the four quadrant multichannel plate detector in the Agilent 8500 FE-SEM by subtracting the right two quadrants from the left two quadrants. Topographic mode highlights fine surface details by effectively generating a real-time shadowing similar to sunlight shining on mountains. Figures 16–19 show the morphology of the coating as well as the increased surface area and at the highest resolution, individual nanotubes in the coating matrix.

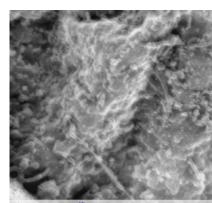


Figure 19. CNT coated microelectrode.

Conclusions

LV FE-SEM provides a straightforward technique for high resolution imaging of carbon nanotubes and carbon nanotube composites, typically without the need for metal coating. Although the application range of nanotubes examined spans many levels of sophistication in materials and processing, the morphological features of interest could easily be investigated with the Agilent 8500 FE-SEM.

References

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